


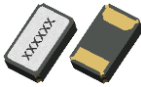
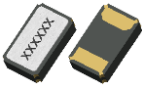
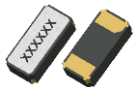




32.768kHz Series Tuning Fork Crystal Units

The 32.768kHz tuning fork crystal unit is the most widely used frequency control product. TAITIEN's tuning-fork-type crystals have low power consumption ideal for portable application. Their different package sizes provide the customers more choices for time management. TAITIEN's tuning-fork-type crystals are cost effective real time clock products.

Type	XA	XB		XD			XN	
Size (mm)	3 x 8	1 x 4	2 x 6	1.6 x 1	2.0 x 1.2	3.2 x 1.5	6.9 x 1.4	8.0 x 3.8
Package	DIP	DIP	DIP	SMD	SMD	SMD	SMD	SMD
RoHS	Yes	Yes	Yes	Yes	Yes	Yes	Yes*	Yes*
Outline								

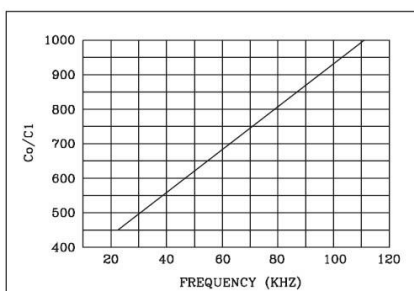
* Pb in high temperature solder (exempt per RoHS 2002/95/EC Annex (7)) and suitable for RoHS compliant reflow

ELECTRICAL SPECIFICATION

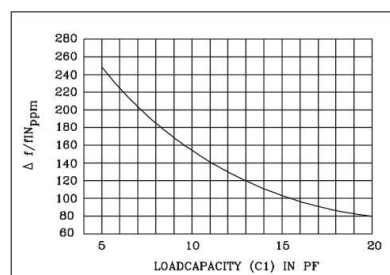
Nominal Frequency	32.768000 kHz
Mode of Vibration	Fundamental
Storage Temp. Range (T _{STR})	-55°C ~ +125 °C
Turnover Temperature (TM)	25±5 °C
Temperature Coefficient (β)	-(0.03±0.01) ppm/°C ²
Frequency vs. Temperature (Δf / fM)	β x (T-TM) ² ppm
Series Resistance (R1)	65~90 KΩ Max.
Level of Drive (DL)	0.1±0.01 uW Typ, 0.5 uW Max.
Aging (first year) (Δf / f0)	±3 ppm Max.
Quality Factor (Q)	30000~60000 Typ.
Shunt Capacitance (C0)	3~7 pF Max.
Load Capacitance (CL)	6, 7, 9, 12.5 pF (Please contact us)
Frequency Tolerance(f _{tol})	±20 ppm @ 25±5 °C
Insulation Resistance	500 MΩ Min. @ DC 100±15 V

Specifications subject to change without notice

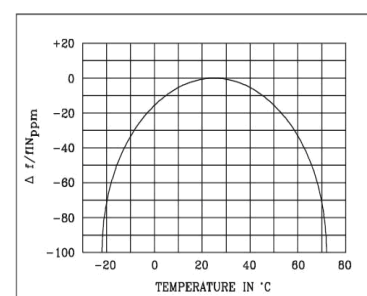
FREQ. vs. CAPACITANCE RATIO (C0/C1)



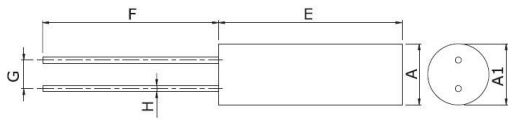
FREQ. vs. LOAD CAPACITANCE (TYP.)



FREQ. vs. TEMPERATURE (TYP.)



DIMENSION (mm) – XA / XB Type

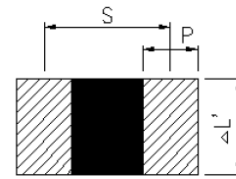
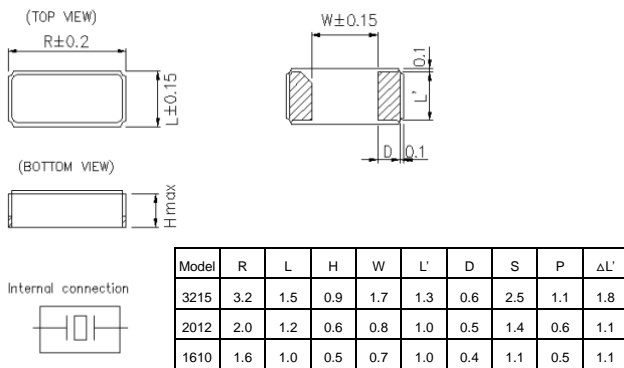


UNIT:mm

TYPE	A	A'	E	F	G	H
XA	3.0	3.1max	8.0max	10±1	0.8±0.2	∅0.32±0.07
XB-N	2.0	2.1max	6.0max	5.0min	0.7±0.2	∅0.28±0.05
XB-J	1.0	1.2max	4.6max	5.7min	0.3±0.05	∅0.18±0.03

DIMENSION (mm) – XD Type

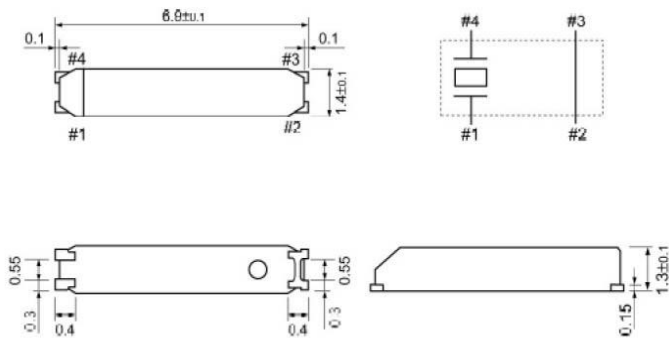
SOLDER PAD LAYOUT (mm)



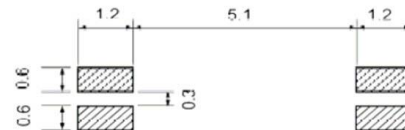
Do not design any patterns on shaded area
 Recommended soldering pattern

DIMENSION (mm) – XN Type

SOLDER PAD LAYOUT (mm)



* Do not connect to external with #2 and #3



DIMENSION (mm) – XN Type

SOLDER PAD LAYOUT (mm)

